## C2D10120-Silicon Carbide Schottky Diode Zero Recovery ${ }^{\text {® }}$ Rectifier

$$
\begin{aligned}
& \mathbf{V}_{\mathbf{R R M}}=1200 \mathrm{~V} \\
& \mathbf{I}_{\mathbf{F}}=10 \mathrm{~A} \\
& \mathbf{Q}_{\mathbf{c}}=61 \mathrm{nC}
\end{aligned}
$$

## Features

- 1200-Volt Schottky Rectifier
- Zero Reverse Recovery
- Zero Forward Recovery
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Extremely Fast Swtitching
- Positive Temperature Coefficient on $\mathrm{V}_{\mathrm{F}}$


## Benefits

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway


## Applications

- Switch Mode Power Supplies
- Power Factor Correction
- Motor Drives

Package


TO-220-2

## Electrical Characteristics

| Symbol | Parameter | Tур. | Max. | Unit | Test Conditions | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{F}$ | Forward Voltage | $\begin{aligned} & 1.6 \\ & 2.5 \end{aligned}$ | $\begin{aligned} & 1.8 \\ & 3.0 \end{aligned}$ | V | $\begin{aligned} & \mathrm{I}_{\mathrm{F}}=10 \mathrm{~A} \quad \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \\ & \mathrm{I}_{\mathrm{F}}=10 \mathrm{~A} \quad \mathrm{~T}_{\mathrm{J}}=175^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |  |
| $\mathrm{I}_{\mathrm{R}}$ | Reverse Current | $\begin{aligned} & 10 \\ & 20 \end{aligned}$ | $\begin{gathered} 200 \\ 1000 \end{gathered}$ | $\mu \mathrm{A}$ | $\begin{aligned} & \hline V_{R}=1200 \vee \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{R}}=1200 \vee \mathrm{~T}_{\mathrm{J}}=150^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |  |
| $\mathrm{Q}_{\mathrm{C}}$ | Total Capacitive Charge | 61 |  | nC | $\begin{aligned} & \mathrm{V}_{\mathrm{R}}=1200 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=10 \mathrm{~A} \\ & \mathrm{~d} / \mathrm{d} t=500 \mathrm{~A} / \mu \mathrm{s} \\ & \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |  |
| C | Total Capacitance | $\begin{gathered} 1000 \\ 80 \\ 59 \\ \hline \end{gathered}$ |  | pF | $\begin{aligned} & V_{R}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C}, \mathrm{f}=1 \mathrm{MHz} \\ & \mathrm{~V}_{\mathrm{R}}=200 \mathrm{~V}_{1} \mathrm{~T}_{\mathrm{J}}=25^{\circ}{ }^{\circ} \mathrm{C}, \mathrm{f}=1 \mathrm{MHz} \\ & \mathrm{~V}_{\mathrm{R}}=400 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C}, \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ |  |

Note:

1. This is a majority carrier diode, so there is no reverse recovery charge.

## Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Unit | Test Conditions | Note |
| :---: | :--- | :---: | :---: | :---: | :---: | :---: |
| $R_{\text {өл }}$ | Thermal Resistance from Junction <br> to Case | 0.48 |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |  |  |

## Typical Performance



Figure 1. Forward Characteristics


Figure 2. Reverse Characteristics

## Typical Performance



Figure 3. Current Derating


Figure 4. Capacitance vs. Reverse Voltage


Figure 5. Transient Thermal Impedance

## Package Dimensions

Package TO-220-2


PIN 1 O

| POS | Inches |  | Millimeters |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max |
| A | .381 | .410 | 9.677 | 10.414 |
| B | .235 | .255 | 5.969 | 6.477 |
| C | .100 | .120 | 2.540 | 3.048 |
| D | .223 | .337 | 5.664 | 8.560 |
| E | .590 | .615 | 14.986 | 15.621 |
| F | .143 | .153 | 3.632 | 3.886 |
| G | 1.105 | 1.147 | 28.067 | 29.134 |
| H | .500 | .550 | 12.700 | 13.970 |
| J | R 0.197 |  |  | R 0.197 |
| L | .025 | .036 | .635 | .914 |
| M | .045 | .055 | 1.143 | 1.397 |
| N | .195 | .205 | 4.953 | 5.207 |
| P | .165 | .185 | 4.191 | 4.699 |
| Q | .048 | .054 | 1.219 | 1.372 |
| S | $3^{\circ}$ | $6^{\circ}$ | $3^{\circ}$ | $6^{\circ}$ |
| T | $3^{\circ}$ | $6^{\circ}$ | $3^{\circ}$ | $6^{\circ}$ |
| U | $3^{\circ}$ | $6^{\circ}$ | $3^{\circ}$ | $6^{\circ}$ |
| V | .094 | .110 | 2.388 | 2.794 |
| W | .014 | .025 | .356 | .635 |
| X | $3^{\circ}$ | $5.5^{\circ}$ | $3^{\circ}$ | $5.5^{\circ}$ |
| Y | .385 | .410 | 9.779 | 10.414 |
| Z | .130 | .150 | 3.302 | 3.810 |

NOTE:

1. Dimension L, M, W apply for Solder Dip Finish

Recommended Solder Pad Layout


| Part Number | Package | Marking |
| :---: | :---: | :---: |
| C2D10120A | TO-220-2 | C2D10120 |

